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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/078,766	02/19/2002	Takeshi Miura	51380	4845
21874	7590	04/16/2004	EXAMINER	
EDWARDS & ANGELL, LLP			LEADER, WILLIAM T	
P.O. BOX 55874				
BOSTON, MA 02205			ART UNIT	PAPER NUMBER
			1742	

DATE MAILED: 04/16/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary	Application No.	Applicant(s)
	10/078,766	MIURA ET AL.
	Examiner	Art Unit
	William T. Leader	1742

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

1) Responsive to communication(s) filed on 09 February 2004.

2a) This action is **FINAL**. 2b) This action is non-final.

3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

4) Claim(s) 5-11 is/are pending in the application.

4a) Of the above claim(s) _____ is/are withdrawn from consideration.

5) Claim(s) _____ is/are allowed.

6) Claim(s) 5-11 is/are rejected.

7) Claim(s) _____ is/are objected to.

8) Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

9) The specification is objected to by the Examiner.

10) The drawing(s) filed on _____ is/are: a) accepted or b) objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).

11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).

a) All b) Some * c) None of:

- Certified copies of the priority documents have been received.
- Certified copies of the priority documents have been received in Application No. _____.
- Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

1) Notice of References Cited (PTO-892)

2) Notice of Draftsperson's Patent Drawing Review (PTO-948)

3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
Paper No(s)/Mail Date 20040209.

4) Interview Summary (PTO-413)
Paper No(s)/Mail Date. _____.

5) Notice of Informal Patent Application (PTO-152)

6) Other: _____.

DETAILED ACTION

1. Receipt of the papers filed on February 9, 2004, is acknowledged. Claims 1-4 have been canceled. New claims 5-11 have been presented.

Claim Rejections - 35 USC § 102

2. Claims 5-11 are rejected under 35 U.S.C. 102(e) as being anticipated by Nagai et al (6,709,563), newly cited.

The Nagai et al patent is directed to a copper-plating bath that is suitable for use in electrodepositing copper to form interconnects, including a trench, on a semiconductor wafer. See Figs. 39A-39C and column 1, lines 31-40. The plating bath should include a complexing agent which can improve plating uniformity (column 2, lines 36-42). The pH of the plating bath may be maintained with a range of 7-14 (column 2, lines 57-60). This range overlaps and anticipates applicant's range as recited in instant claim 5 at pH values of 7-8.4. Thus, all elements recited in claim 5 are taught by Nagai et al.

Nagai et al disclose a number of suitable complexing agents. These include ethylenediamine tetramethylene phosphonic acid and diethylenetriamine pentamethylene phosphonic acid (column 3, lines 22-31). This portion of the Nagai et al patent teaches the limitations of claims 6, 7, 9 and 10.

Nagai et al further discloses that the copper-plating bath can be used in plating over an outer seed layer to reinforce the thin portion of the seed layer. See the abstract. This portion of Nagai et al teaches the limitation recited in instant claims 8 and 11.

3. Claims 5 and 8 are rejected under 35 U.S.C. 102(e) as being anticipated by Krishnamoorthy et al, newly cited.

The Krishnamoorthy et al patent is directed to a copper alloy electroplating bath for microelectronic applications. One known method for forming interconnects is the dual damascene process in which trenches and vias are formed by etching in a dielectric layer on the semiconductor wafer. Barrier and seed layers are formed and copper is deposited to fill the openings. See column 2, lines 43-67. Krishnamoorthy et al disclose the use of a copper electroplating bath containing a minor amount of alloying metal. Table 1 (column 7) lists a preferred electroplating solution. The solution contains ED or EDTA which serves as a complexing agent and has a pH of about 8 to 11. The inclusion of complexing agents is also disclosed at column 6, lines 48-53. The disclosed pH range overlaps and anticipates applicant's range as recited in instant claim 5 at pH values of 8.0-8.4. Thus, Krishnamoorthy et al teach all limitation of instant claims 5 and 8.

Claim Rejections - 35 USC § 103

4. Claims 6, 7 and 9-11 are rejected under 35 U.S.C. 103(a) as being unpatentable over Krishnamoorthy et al in view of Florio et al. Krishnamoorthy et al is taken as above. Claims 6, 7 and 9-11 differ from Krishnamoorthy et al by reciting particular complexing agents. The Florio et al patent is directed to an electroplating process. In a part of the process a solution containing copper complexing agents is used. Suitable copper complexing agents include ethylenediamine tetraacetic acid (EDTA) and triethanolamine (column 8, lines 38-58). The prior art of record is indicative of the level of skill of one of ordinary skill in the art. It would have been obvious to have utilized triethanolamine as a copper complexing agent in the process of Krishnamoorthy et al because triethanolamine and EDTA are taught to be equivalents by Florio et al.

5. Applicant's arguments with respect to claims 5-11 have been considered but are moot in view of the new ground(s) of rejection.

6. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to William T. Leader whose telephone number is 571-272-1245. The examiner can normally be reached on Mondays-Thursdays and alternate Fridays, 7:30-4:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Roy King can be reached on 571-272-1244. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

WL
William Leader
April 8, 2004

ROY KING
SUPERVISORY PATENT EXAMINER
TECHNOLOGY CENTER 1700